

Zener Diodes

CDZ55C-TM Series

CHIP DIODE

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Zener Diodes CDZ55C-TM Series



FEATURES

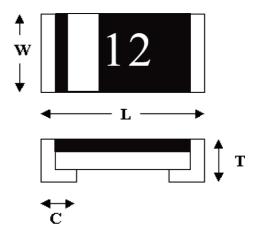
- Silicon planar power zener diodes
- SMD chip pattern
- Leadfree and RoHS compliance components
- Zener-M series as low IR suit for mobile design

MECHANICAL CHARACTERISTICS

- Size: 0603 (SOD-523 equivalent)
- Weight: approx. 4mg
- Marking: Zener voltage & cathode terminal

DIMENSIONS

Dimension/mm	0603
L	1.55±0.1
W	0.8±0.1
Т	0.65±0.1
С	0.35±0.1



MAXIMUM RATING & THERMAL CHARACTERISTICS¹⁾

Parameter at T _{amb} =25°C ¹⁾	Symbol	Value	Unit
Power Dissipation	P _{tot}	500	mW
Repetitive Peak Forward Current	I _{FRM}	200	mA
Junction Temperature	T _j	150	°C
Thermal Resistance Junction to Ambient air	R _{eja}	300	°C/W
Operating & Storage Temperature range	T _{opr, sta}	-55 to 150	°C

1) Valid provided that electrodes are kept at ambient temperature.



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ELECTRICAL CHARACTERISTICS¹⁾

Parameter at T _{amb} =25°C ¹⁾	Symbol	Value	Unit
Forward Voltage at I _F =200mA	V _F	1.5 _{MAX}	V
Zonor Voltago Toloranco, C-+E0/			

Zener Voltage Tolerance, C=±5%

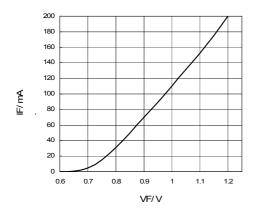
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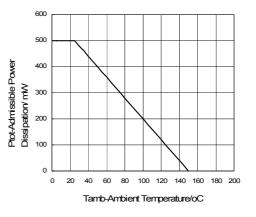
Part Number	Marking		al Zener age	Max Zener Impedance			Max Reverse Leakage Current		
	Code	V _Z @ I _{ZT}		Z _{ZT} @ I _{ZT}		Z _{ZK} @ I _{ZK}		I _R @ V _R	
		Min V	Max V	Ω	mA	Ω	mA	μA	V
CDZ55C5V1TM	E1	4.85	5.36	50	5	550	1	0.1	1
CDZ55C5V6TM	E6	5.32	5.88	30	5	450	1	0.1	1

TYPICAL CHARACTERISTICS

Figure 1. Forward current vs Forward Voltage

Figure 2. Power De-rating





TEST CHARACTERISTICS

Test Item	Test Condition	Requirement
Solderability	Sn bath at 245±5°C for 2±0.5s	>95% area tin covered
Resistance to Soldering Heat	Sn bath at 260±5°C for 10±2s	$V_F, V_Z \& I_R$ within spec; no mechanical damage
Humidity Steady State	At 85°C 85%RH for 168hrs	$V_{\text{F}} V_{\text{Z}} \& I_{\text{R}}$ within spec
Continue Forward Operating Life	At 25°C I _F =1.1I _F for 1000hrs	$V_F, V_Z \& I_R$ within spec
Thermal Shock	$-55 \pm 5^{\circ}$ C/5min to $150\pm 5^{\circ}$ C/5min for 10cycles	$V_F, V_Z \& I_R$ within spec
Bending Strength	Bending up to 2mm for 1cycle	$V_F, V_Z \& I_R$ within spec; no mechanical damage



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APPLICATIONS

- Function: constant voltage control
- Soldering Condition:

Soldering Condition & Caution

Recommended Profile Condition	Sn-Pb Soldering	Leadfree Soldering	Wave Soldering
Ramp-up rate (from pre-heat stage)	<3°C/s	<3°C/s	∆T<150°C
Dra haat Tamparatura & Tima	100-150 °C	150-200 °C	100-150 °C
Pre-heat Temperature & Time	60-120s	60-120s	60-120s
Soldering Temperature & Time	183 °C	217 °C	260±5°C
	60-150s	60-150s	5±2s
Dook Tomporatura	230±5°C	245±5°C	260±5°C
Peak Temperature	<260°C	<260°C	200±5°C
Time within 5°C of peak temperature	10-20s	20-30s	-
Ramp-down rate	<6°C/s	<6°C/s	<6°C/s
Time 25°C to peak temperature	<6min	<8min	-

Recommended Soldering Profile

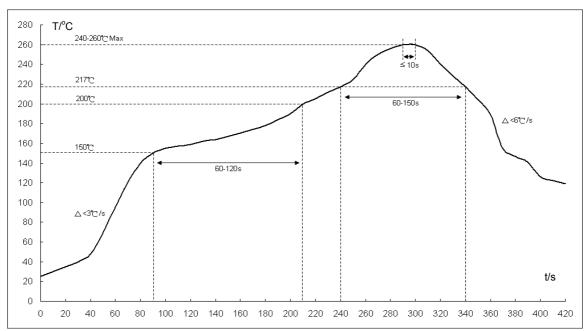


Fig1: Reflow soldering profile for lead-free solder (SnAgCu)

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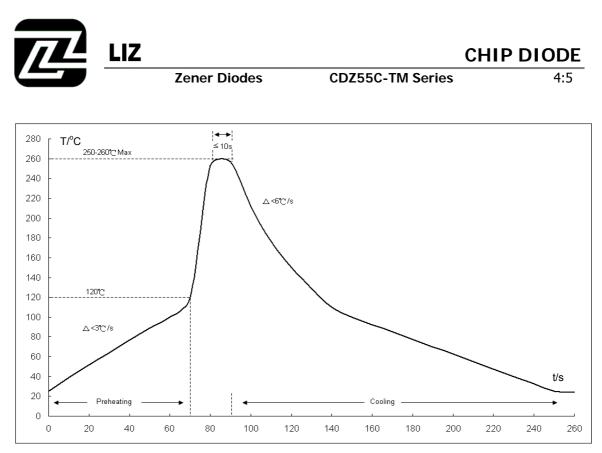
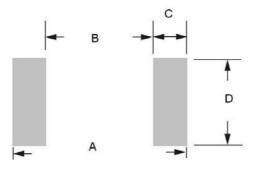


Fig2: Wave soldering profile

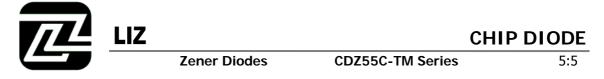
- *1. The recommended profiles are referring to IPC/JEDEC J-STD-020D & IEC-60068-2-58
- *2. Chip diodes are able to stand maximum soldering temperature up to 260°C max for 10s, and the soldering cycles with max 3 times, referring to IEC-60068-2-58
- Recommended Soldering Footprint:



Reflow/Wave	Soldering
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Product Sizo		Dimensi	on/ mm	
Product Size	А	В	С	D
0603	1.8-2.6	0.8	0.5-0.9	0.8-1.0

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Storage Condition: Product termination solderability can degrade due to high temperature and humidity or chemical environment. Storage condition must be in an ambient temperature of <40°C and ambient humidity of <75%RH, and free from chemical.</p>

ENVIRONMENTAL CHARACTERISTICS

	Hazardous Substance or Element/ppm					pm
Product	Pb	Cd	Hg	Cr ⁶⁺	PBB	PBDE
	<1000	<100	<1000	<1000	<1000	<1000

	Halogen Substance/ ppm				
Product	F	Cl	Br	Ι	Total
	<900	<900	<900	<900	<1500

PACKING METHOD

Product	Quality/Reel	Reel Size	Таре
	5,000pcs	7″	Paper

DISCLAIMERS

These products are not designed for use in applications where any failure or malfunction may resulted in personal injury, death or severe property or environmental damage such as medical, military, aircraft, space or life support equipments.